

PRESS RELEASE

Fremont, California, June 22, 2018 – Hesse Mechatronics Inc., the American subsidiary of Hesse GmbH, world leader in ultrasonic wedge bonders for the power, automotive, military, medical, RF & Microwave and HiRel markets, have announced the addition of two new key employees, Mr. Rene Cruz and Mr. Vicmark Divinagracia.



Rene Cruz joined Hesse Mechatronics Inc. this past May as a Field Service Engineer to provide technical support and training. Rene was introduced to wire bonding while employed at Continental Automotive. He graduated with his Associate's Degree in Mechanical Engineering Technology from Lone Star College then went on to obtain his Bachelor of Science Degree from The University of Houston. Rene has taught CAD Design and Robotics and has experience with computer programming languages, PLC software, die bonding and numerous electro-mechanical machines.



Vicmark Divinagracia has over 20 years of experience in Semiconductor and Equipment Assembly. He was previously with F&K Delvotec USA and Singapore sites as a Wire Bond Service and Applications Engineer. He has worked for Philips Semiconductors-Philippines, Fairchild Semiconductors-Philippines and Infineon Technologies-Indonesia in engineering positions responsible for developing new processes in semiconductor applications. Lately, Vicmark has been working on developing bond process parameters for wire bonding batteries for electric vehicles. Vicmark is a graduate of The University of St. La Salle- Philippines, with a degree in Bachelor of Science in Electronics Engineering.

About Hesse Mechatronics

Hesse GmbH is a privately held company based in Paderborn, Germany that is a leading designer and manufacturer of high-speed, fine-pitch ball, fine wedge/ribbon, heavy wedge/ribbon wire bonders. Hesse Mechatronics also provides standard or customized indexers with or without handling systems. Hesse has subsidiaries in the Americas, Asia and Japan.

For more information about Hesse Mechatronics, please contact Mike McKeown, Sr. New Business Development Manager at 516-551-8671 or michael.mckeown@hesse-mechatronics.com To view our wire bond videos, please register at www.wirebonddemo.com